

IC Socket Type: **LGA 1155**

Number of Positions: **1155**

Termination Method to PCB: **Surface Mount - Solder Ball**

Grid Spacing: **.914 x .914 mm [.036 x .036 in]**

EU RoHS Compliance: **Compliant**

Features

Housing Features

Housing Material	High Temperature Thermoplastic
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Industry Standards

UL Flammability Rating	UL 94V-0
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Body Features

Frame Style	Square, Small
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Packaging Features

Tray Color	Black
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Packaging Method	Box
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Contact Features

Contact Mating Area Plating Material	Gold Flash
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Contact Base Material	Copper Alloy
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IC Socket Type	LGA 1155
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Configuration Features

Number of Positions	1155
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Grid Spacing	.914 x .914 mm [.036 x .036 in]
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Termination Features

Termination Method to PCB	Surface Mount - Solder Ball
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Other

EU RoHS Compliance	Compliant
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUN 2018 (191) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Customers Also Bought



TE Part #1734753-1
MINI USB, TYPE B, VERTICAL, T/H



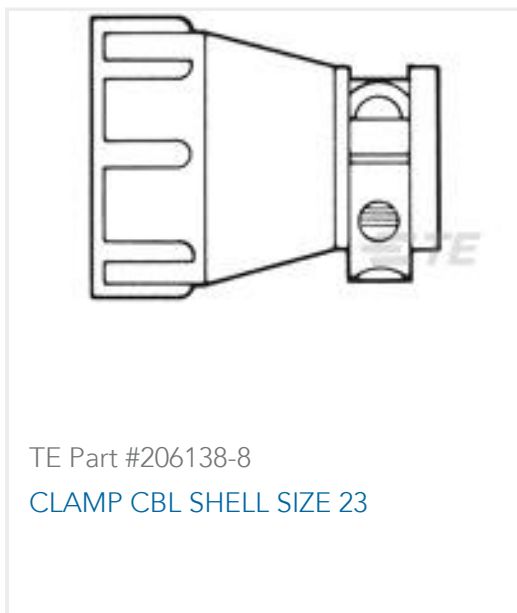
TE Part #1-66098-8
III+ PIN,18-16,TIN STRIP



TE Part #3-66104-0
III+ SKT,24-20,TIN ,STRIP



TE Part #5406299-1
MJ ASSY,S/P,8POS,SH,RVPGT,CAT 5e



Documents

CAD Files

Customer View Model

[ENG_CVM_CVM_2069965-3_E.2d_dxf.zip](#)

English

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_2069965-3_E.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2069965-3_E.3d_stp.zip](#)

English

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